任意 加工深度, N.A., 晶体, 切向, pattern (目标: Z 偏 HG₄₄)

- 7.0·10⁶

 $6.0 \cdot 10^6$

 $5.0 \cdot 10^6$

 $4.0 \cdot 10^{6}$

晶体内: 就一个光斑; 100 μm 厚 x 切 LN; 光强 XZ, XY 剖面;

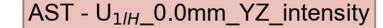
目标: 80 µm 深;

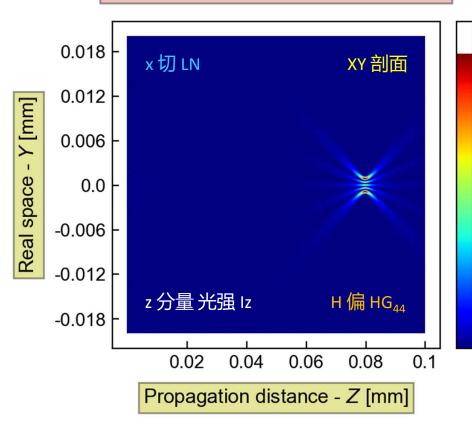
任何深度 光斑: 自定义

标量 全息图: H 偏 HG44

H 偏标量 $\rightarrow LN \rightarrow H$ 偏 HG_{44} ; \bar{n} = 2.2291; z_0 = 80 μ m; θ = 29.18°; N.A. = 0.49; $\lambda = 800 \text{ nm}; \, \omega_0 = 500 \text{ nm};$

Intensity distribution





AST - U_{1/H} 0.0mm XZ intensity $9.0 \cdot 10^{6}$ 8.0·10⁶ 0.018

